

What you will do

- Develop modules and wafer fabrication processes for discrete SiC power products like diodes and MOSFET on site or in other locations
- Work as a team member of product development projects, together in a multi-disciplinary team with product experts, process and production engineers as well as quality engineers
- Conduct small and medium size process optimization projects in the wafer fab
- Build up know how (technical & procedures) in silicon and SiC wafer processes
- Investigate competitor processes and technologies
- Build up and maintain internal contacts

What you will need

- Minimum Master's degree in engineering field, preferably in microelectronics or semiconductor physics
- Knowledge of semiconductor devices and industrial semiconductor technology with special focus on SiC processes
- Hands on experience in wafer processing at the required equipment
- Team player with a strong drive to achieve success
- Good organization and planning skills
- Fluent in English and German, both written and spoken

More information?

For more details please contact: john.perez@nexperia.com

Are you interested in this career challenge?

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Location
Hamburg
Employment type
Fulltime
Contract duration
Permanent
Job-id
R-20007263

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